

5555 NE Moore Ct.

## **Device Material Content**

Assembly: ASEK

Hillsboro OR 97124 Package Code: Size (mm): 17 x 17 custreg@latticesemi.com Package: 208 ftBGA **FTG208** Lead pitch (mm): 1.0 **Total Device Weight** 0.750 Grams **Products:** MSL: 3 LPTM10 Reflow max (°C): 260 June, 2022 % of Total % of Total Weight (g) Weight (g) CAS# Substance % of Subst. Notes / Assumptions: Pkg. Wt. Pkg. Wt. Die 1.48% 0.0111 Die size: 3.25 x 3.25 mm + 2.65 x 2.65 mm 1.48% 0.0111 Silicon chip 7440-21-3 100.00% Side-by-side (dual-die) 54.91% 0.4118 Mold Compound: Kyocera G2250LKDS series (ULA) Mold Compound 48.05% 0.3604 60676-86-0 87.50% Silica 3.57% 0.0268 6.50% Epoxy resin 3.02% 0.0227 Phenol Resin 5.50% 0.27% 0.0021 Carbon Black 1333-86-4 0.50% D/A Epoxy 0.24% 0.0018 Die attach epoxy: Henkel (Ablebond) 2100A 0.19% 0.00143 Silver 7440-22-4 80.00% 0.05% 0.00036 Esters & resins 20.00% 0.40% 0.0030 0.7 mil diameter; 1 wire per solder ball Wire 0.39% 0.0029 Gold (Au) 7440-57-5 98.50% Solder Balls 13.46% 0.1009 SAC305 12.99% 0.0974 Tin (Sn) 7440-31-5 96.50% 0.40% 0.0030 Silver (Ag) 7440-22-4 3.00% 0.07% 0.0005 Copper (Cu) 7440-50-8 0.50% Substrate 17.42% 0.1306 BT Resin CCL-HL832NX-A 5.57% 0.0418 BT Resins 32.00% 11.84% 0.0888 Glass fiber 65997-17-3 68.00% Foil 7.92% 0.0594 6.49% 0.0487 7440-50-8 82.00% Copper 1.20% 0.0090 Nickel 7440-02-0 15.10% 0.23% 0.0017 Gold 7440-57-5 2.91% Solder Mask 4.18% 0.0314 Solder mask PSR4000 AUS 308 2.35% 0.0176 14808-60-7 56.20% Quartz 0.67% 0.0050 3-methoxy-3-methylbutylacetate 103429-90-9 16.00% 0.92% 0.0069 Barium Sulfate 7727-43-7 22.00% Talc (containing no asbestiform fibers) 0.13% 0.0009 14807-96-6 3.00% 0.12% 0.0009 Trade secret ingredients 2.80%

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